Photocouplers Photorelay

TLP220GF

1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment
- Smart Meters
- Electricity Meters

2. General

The TLP220GF photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

3. Features

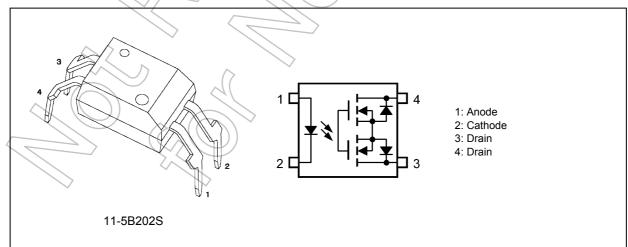
- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 350 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 100 mA (max)
- (5) ON-state resistance: 35Ω (max, t < 1s)
- (6) ON-state resistance: 50Ω (max, Continuous)
- (7) Isolation voltage: 5000 Vrms (min)
- (8) Safety standards
 - UL-approved: UL1577 File No. E67349

cUL-approved: CSA Component Acceptance Service No. 5A, File No. E67349

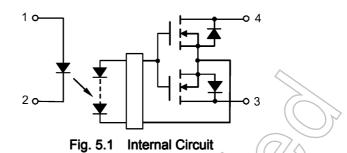
VDE-approved: Option (D4) EN60747-5-5 (Note)

Note: When an EN60747-5-5 approved type is needed, please designate the Option (D4)

4. Packaging and Pin Configuration



5. Internal Circuit



6. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP220G	10.16-mm Pitch TLP220GF	Unit	
Creepage distances	7.0 (min)	8.0 (min)	mm	
Clearance distances	7.0 (min)	8.0 (min)	\bigcirc	
Internal isolation thickness	0.4 (min)	0.4 (min)	(//	$\left(\right)$

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$)

			(\square)		
	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	IF (7	\sum	30	mA
	Input forward current derating $(T_a \ge 25^{\circ}C)$	$\Delta I_F / \Delta T_a$	$\bigcirc)$	-0.3	mA/°C
	Input forward current (pulsed) (100 μs pulse, 100 pps)	J FP		1	A
	Input reverse voltage	VR		5	V
	Input power dissipation	P ₀		50	mW
	Junction temperature	Tj		125	°C
Detector	OFF-state output terminal voltage	V _{OFF}		350	V
	ON-state current	I _{ON}		100	mA
	ON-state current derating $(T_a \ge 25^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$		-1.0	mA/°C
	ON-state current (pulsed) (t = 100 ms, Duty = 1/10)	I _{ONP}		300	mA
	Output power dissipation	Po		500	mW
	Junction temperature	Τj		125	°C
Common	Storage temperature	T _{stg}		-55 to 125	
	Operating temperature	T _{opr}		-40 to 85	
	Lead soldering temperature (10 s)	T _{sol}		260	
	Isolation voltage AC, 1 min, R.H. ≤ 60%	BVS	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	—	280	V
Input forward current	١ _F		3	5	15	mA
ON-state current	I _{ON}	4	7	_	100	
Operating temperature	T _{opr}		-20	_	65	C°

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

9. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I _R		V _R = 5 V	_	A	10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	- /	40		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 350 V	, –((D+a	1	μA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	X	- (30/)	/ _	pF

10. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	(1 _{ON} = 100 mA)) _	0.3	2	mA
Return LED current	I _{FC}	く	I _{OFF} = 10 μA	0.1	_	_	mA
ON-state resistance	R _{ON}		I _{ON} = 100 mA, I _F = 5 mA, t < 1 s		25	35	Ω
		(Note 1)	I _{ON} = 100 mA, I _F = 5 mA, Continuous	_	35	50	

Note 1: Thermally saturated state.

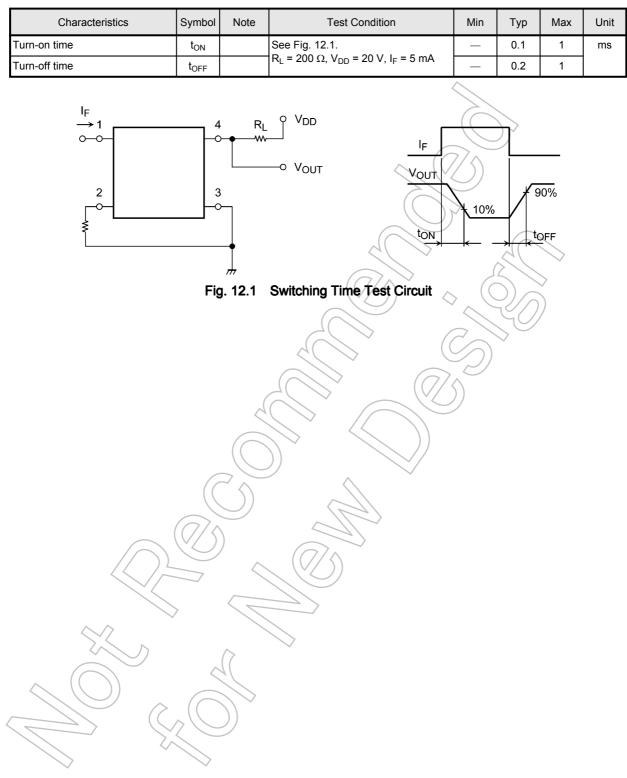
11. Isolation Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _{\$} = 0 V, f = 1 MHz	_	0.8	—	pF
Isolation resistance	Rs	(Note 1)	$V_{S} = 500 V, R.H. \le 60\%$	$1 imes 10^{12}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 1 min	5000	_	_	Vrms
	<		AC, 1s in oil	_	10000	_	
\sim			DC, 1 min, in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

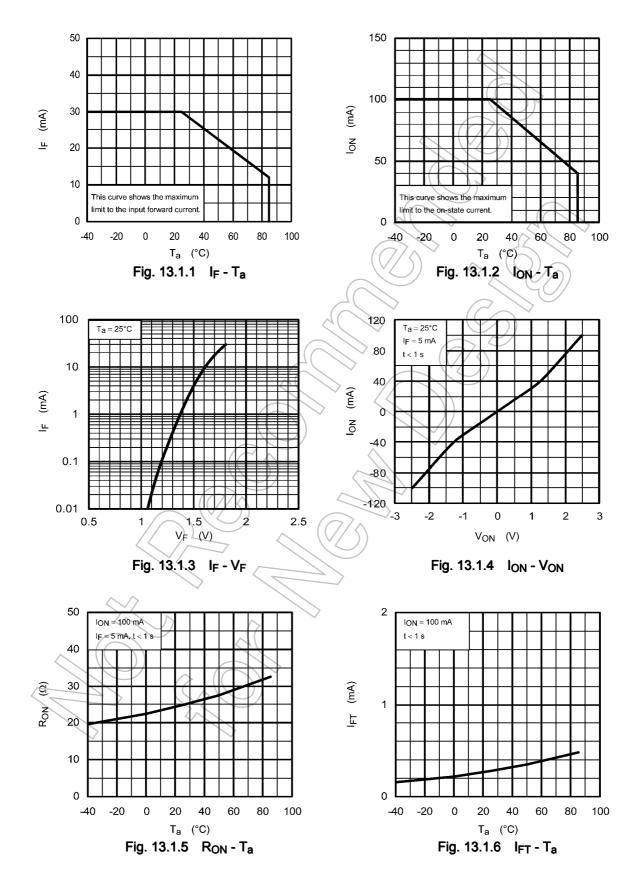


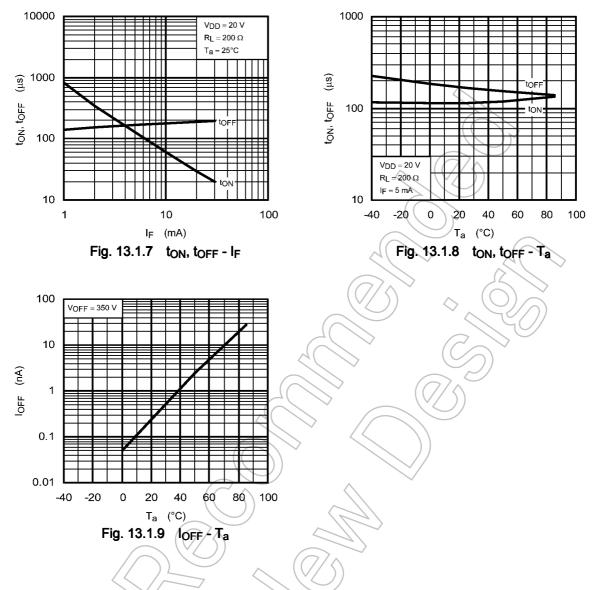
12. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)



13. Characteristics Curves







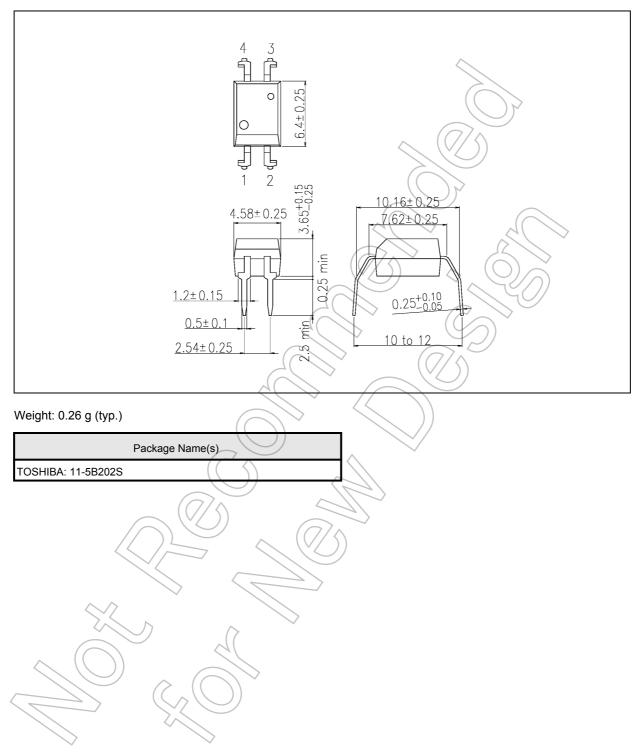
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





Package Dimensions

Unit: mm



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